

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT														
NATURE OF CONVEYANCE:	ASSIGNMENT														
CONVEYING PARTY DATA															
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<table border="1"> <tr> <td>Name:</td> <td>Taiwan Semiconductor Manufacturing Co., Ltd.</td> </tr> <tr> <td>Street Address:</td> <td>No. 8, Li-Hsin Rd. 6</td> </tr> <tr> <td>Internal Address:</td> <td>Hsin-Chu Science Park</td> </tr> <tr> <td>City:</td> <td>Hsin-Chu</td> </tr> <tr> <td>State/Country:</td> <td>TAIWAN</td> </tr> <tr> <td>Postal Code:</td> <td>300-77</td> </tr> </table>		Name:	Taiwan Semiconductor Manufacturing Co., Ltd.	Street Address:	No. 8, Li-Hsin Rd. 6	Internal Address:	Hsin-Chu Science Park	City:	Hsin-Chu	State/Country:	TAIWAN	Postal Code:	300-77		
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<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13948217</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13948217										
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CORRESPONDENCE DATA															
<p>Fax Number: 2165020601 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 212-502-0600 Email: docketing@eschweilerlaw.com Correspondent Name: Eschweiler & Associates, LLC. Address Line 1: 629 Euclid Avenue, Suite 1000 Address Line 2: National City Bank Building Address Line 4: Cleveland, OHIO 44114</p>															
ATTORNEY DOCKET NUMBER:	TSMCP292US														

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NAME OF SUBMITTER:	Thomas G. Eschweiler
Signature:	/Thomas G. Eschweiler/
Date:	07/23/2013
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U.S. Patent Appln. No.

Docket No. TSMCP292US

Filing Date:

PATENT ASSIGNMENT

PARTIES TO THE ASSIGNMENT

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Docket No. TSMCP292US

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AGREEMENT

WHEREAS, ASSIGNOR(S) (listed above) are inventor(s) of an invention entitled "PHOTODIODE GATE DIELECTRIC PROTECTION LAYER" for which:

a non-provisional application for United States Letters Patent:

☒ was executed on even date preparatory to filing (each inventor should sign this Assignment on the same day as he/she signs the Declaration and Power of Attorney); or

☐ was filed on _____ and accorded U.S. Serial No. _____; or

☐ will be filed without this executed PATENT ASSIGNMENT. ASSIGNOR hereby authorizes and requests ASSIGNEE'S legal representatives, the attorneys associated with Customer No. _____, to insert below in this document this APPLICATION's U.S. Serial Number and filing date, when known:

U.S. Serial No. _____,

filed on _____.

WHEREAS, ASSIGNEE (listed above), a corporation of the Republic of China is desirous of acquiring the entire right, title and interest in and to the invention and in and to any letters patent that may be granted therefore in the United States and in any and all foreign countries;

NOW, THEREFORE, in exchange for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sell, assign and transfer unto ASSIGNEE its successors and assigns, the entire right, title and interest in and to said invention and improvements, said application and any and all letters patent which may be granted for said invention in the United States of America and its territorial possessions and in any and all foreign countries, and in any and all divisions, reissues, re-examinations and

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continuations thereof, including the right to file foreign applications directly in the name of ASSIGNEE and to claim priority rights deriving from said United States application to which said foreign applications are entitled by virtue of international convention, treaty or otherwise, said invention, application and all letters patent on said invention to be held and enjoyed by ASSIGNEE and its successors and assigns for their use and benefit and of their successors and assigns as fully and entirely as the same would have been held and enjoyed by ASSIGNOR(S) had this assignment, transfer and sale not been made. ASSIGNOR(S) hereby authorize and request the Commissioner of Patents and Trademarks to issue all letters patent on said invention to ASSIGNEE. ASSIGNOR(S) agree to execute all instruments and documents required for the making and prosecution of applications for United States and foreign letters patent on said invention, for litigation regarding said letters patent, or for the purpose of protecting title to said invention or letters patent therefore.

2013/7/11
Date

Cheng-Hsien Chou
Name 1st Inventor Cheng-Hsien Chou

TSMC Docket No. TSMC2013-0410

Docket No. TSMCP292US

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Filing Date:

2013/09/11
Date

Wen-I Hsu
Name 2nd Inventor Wen-I Hsu

TSMC Docket No. TSMC2013-0410

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Filing Date:

2013-7-11
Date

Tsun-Kai Tsao
Name 3rd Inventor Tsun-Kai Tsao

TSMC Docket No. TSMC2013-0410

U.S. Patent Appln. No.

Docket No. TSMCP292US

Filing Date:

2013/7/11
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Chih-Yu Lai
Name 4th Inventor Chih-Yu Lai

U.S. Patent Appln. No.

Filing Date:

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Date

TSMC Docket No. TSMC2013-0410

Docket No. TSMCP292US

Jiech-Fun Lu
Name 5th Inventor Jiech-Fun Lu


TSMC Docket No. TSMC2013-0410

U.S. Patent Appln. No.

Docket No. TSMCP292US

Filing Date:

✓ 2013/12/11
Date


Name ⁶ Inventor Yeur-Luen Tu